




**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Per Møller  
Serial No. : 10/529,467  
Filed : March 28, 2005  
For : METHOD FOR PRETREATING A SURFACE OF A NON-  
CONDUCTING MATERIAL TO BE PLATED  
Group A. U. : 1775  
Conf. No. : 8292  
Examiner : Michael E. Lavilla

I hereby certify that this paper is being deposited this date with the  
U.S. Postal Service in first class mail addressed to Commissioner  
for Patents, P.O. Box 1450, Alexandria, VA 22123-1450.  
 May 4, 2007  
Richard F. Jaworski Date  
Reg. No. 33,515

COOPER & DUNHAM LLP  
1185 Avenue of the Americas  
New York, New York 10036  
(212) 278-0400

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT AFTER FINAL REJECTION**

In response to the final Office Action dated December 4, 2006, the time for responding to which having been extended to May 4, 2007 by the accompanying two month Petition For Extension of Time, please amend the above-identified application as follows:

**Amendments to the claims** are reflected in the listing of claims that begins on page 3 of this paper.

**Remarks** begin on page 6 of this paper.